



# 10N65T

*Power MOSFET*

## 10A, 650V N-CHANNEL POWER MOSFET

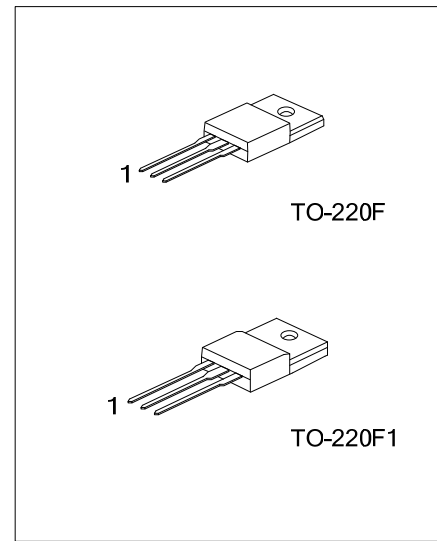
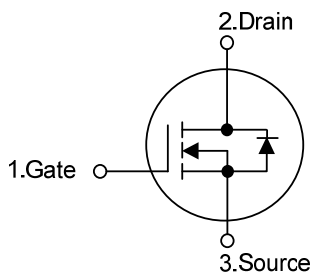
■ DESCRIPTION

The **UTC 10N65T** is a high voltage and high current power MOSFET, designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

■ FEATURES

- \*  $R_{DS(ON)} < 0.95\Omega @ V_{GS} = 10V$
- \* Fast switching
- \* 100% avalanche tested
- \* Improved dv/dt capability

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
10N65TL-TF3-T	10N65TG-TF3-T	TO-220F	G	D	S	Tube
10N65TL-TF1-T	10N65TG-TF1-T	TO-220F1	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>10N65TL-TF3-T</p> <p>(1)Packing Type (2)Package Type (3)Lead Free</p>	<p>(1) T: Tube (2) TF3: TO-220F, TF1: TO-220F1 (3) L: Lead Free, G: Halogen Free</p>
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■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	650	V
Gate-Source Voltage	$V_{GSS}$	$\pm 30$	V
Avalanche Current (Note 2)	$I_{AR}$	10	A
Drain Current	Continuous	$I_D$	10
	Pulsed (Note 2)	$I_{DM}$	38
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	90
	Repetitive (Note 2)	$E_{AR}$	15.6
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns
Power Dissipation	$P_D$	50	W
Junction Temperature	$T_J$	+150	$^\circ\text{C}$
Operating Temperature	$T_{OPR}$	-55 ~ +150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3.  $L = 1.8\text{mH}$ ,  $I_{AS} = 10\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\ \Omega$  Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 9.5\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

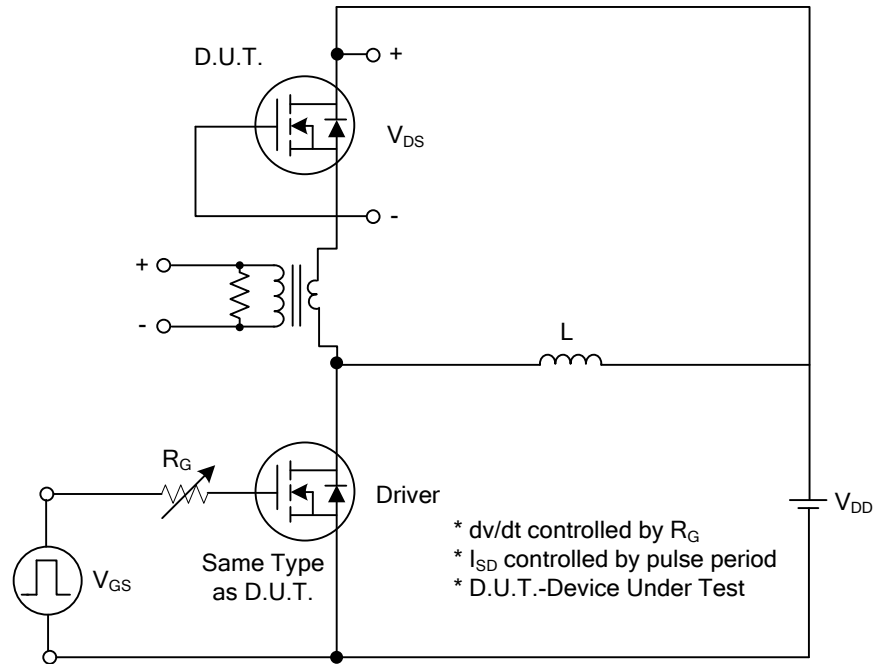
PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
Junction to Case	$\theta_{JC}$	2.5	$^\circ\text{C}/\text{W}$

■ ELECTRICAL CHARACTERISTICS(  $T_C=25^\circ\text{C}$ , unless otherwise specified)

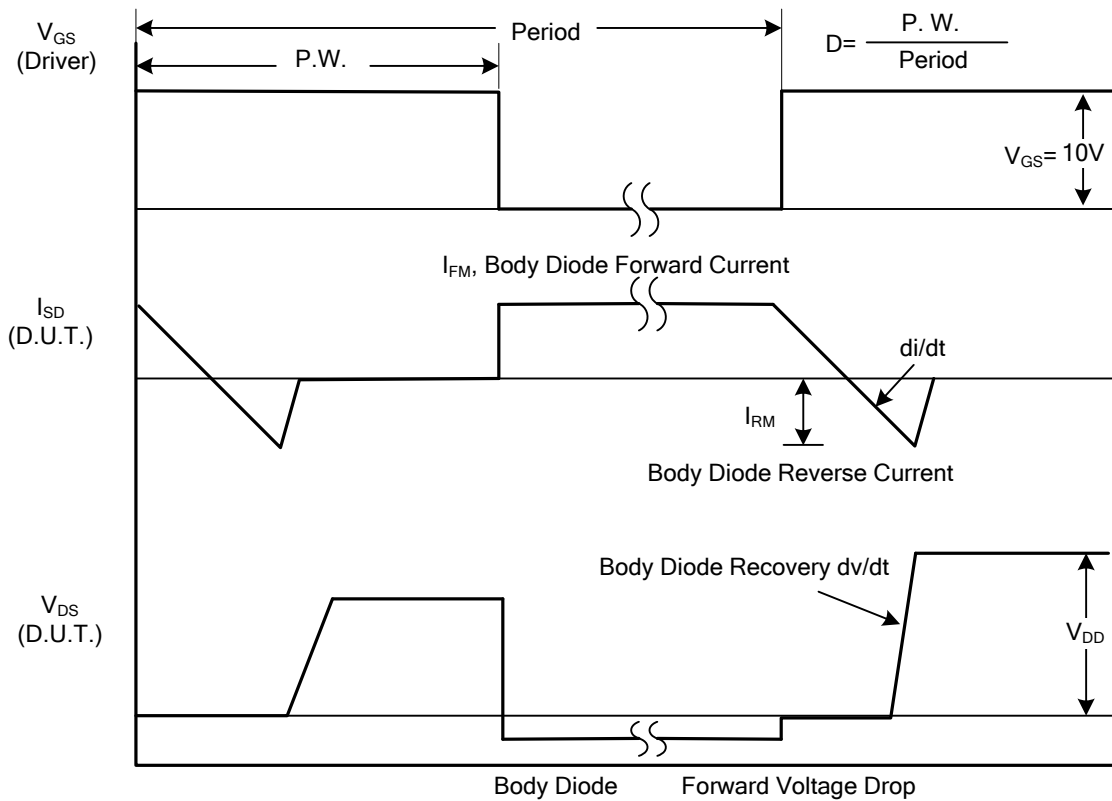
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	650			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=520V, V_{GS}=0V, T_J=125^\circ\text{C}$			100	$\mu A$
Gate-Source Leakage Current	Forward	$I_{GSS}$				nA
	Reverse					
		$V_{GS}=-30V, V_{DS}=0V$			-100	nA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	$I_D=250\mu A$ , Referenced to $25^\circ\text{C}$		0.7		$V/^\circ\text{C}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=4.75A$		0.88	0.95	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=25V, V_{GS}=0V, f=1.0\text{ MHz}$		1250	2040	pF
Output Capacitance	$C_{OSS}$			120	215	pF
Reverse Transfer Capacitance	$C_{RSS}$			13	24	pF
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=30V, I_D=0.5A, R_G=25\Omega$ (Note1, 2)		38	55	ns
Turn-On Rise Time	$t_R$			48	130	ns
Turn-Off Delay Time	$t_{D(OFF)}$			316	330	ns
Turn-Off Fall Time	$t_F$			70	150	ns
Total Gate Charge	$Q_G$	$V_{DS}=50V, I_D=10A, V_{GS}=10V$ (Note1, 2)		100	120	nC
Gate-Source Charge	$Q_{GS}$			20		nC
Gate-Drain Charge	$Q_{GD}$			19		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=10A$			1.4	V
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				10	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{SM}$				38	A
Reverse Recovery Time	$t_{rr}$	$V_{GS}=0V, I_S=10A,$		420		ns
Reverse Recovery Charge	$Q_{RR}$	$di_f/dt=100A/\mu s$ (Note1)		4.2		$\mu C$

- Notes: 1. Pulse Test : Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$   
 2. Essentially independent of operating temperature

## TEST CIRCUITS AND WAVEFORMS

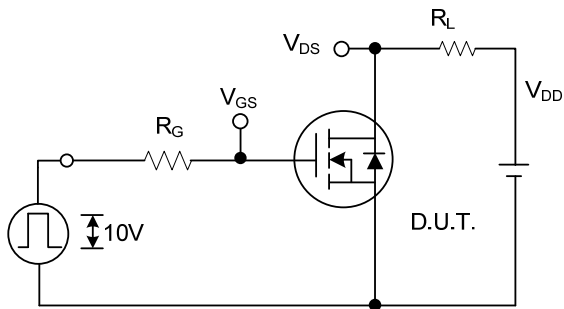


Peak Diode Recovery  $dv/dt$  Test Circuit

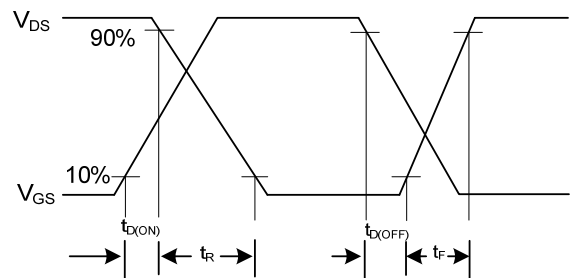


Peak Diode Recovery  $dv/dt$  Waveforms

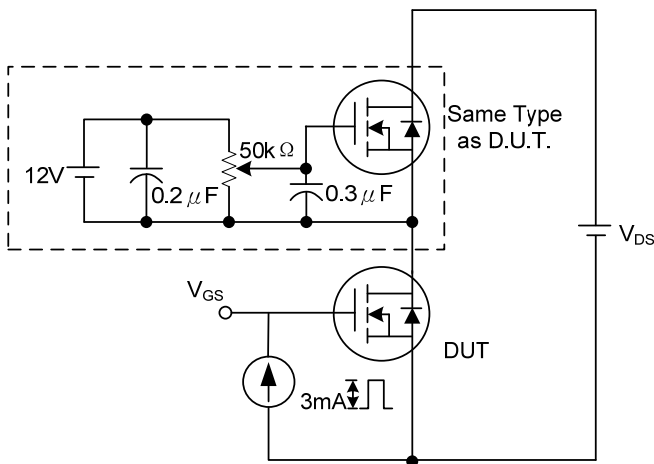
### ■ TEST CIRCUITS AND WAVEFORMS (Cont.)



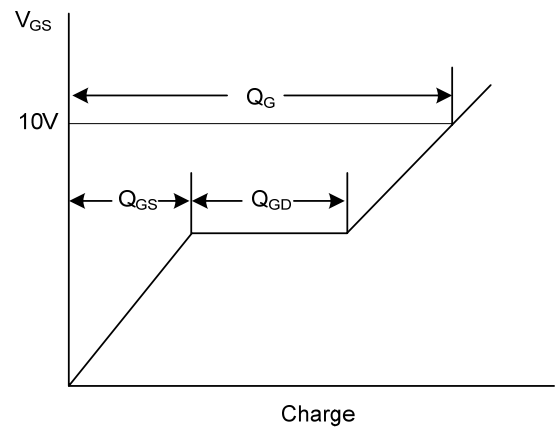
**Switching Test Circuit**



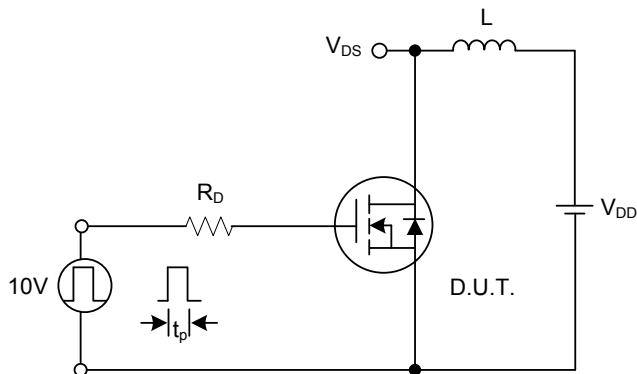
**Switching Waveforms**



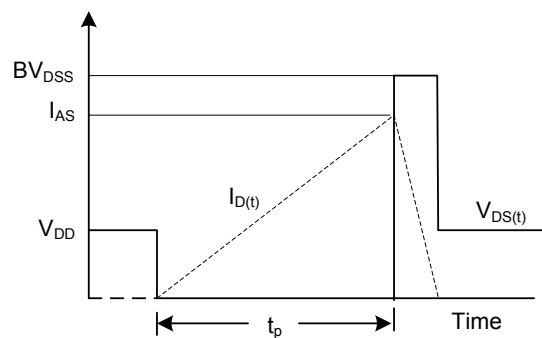
**Gate Charge Test Circuit**



**Gate Charge Waveform**

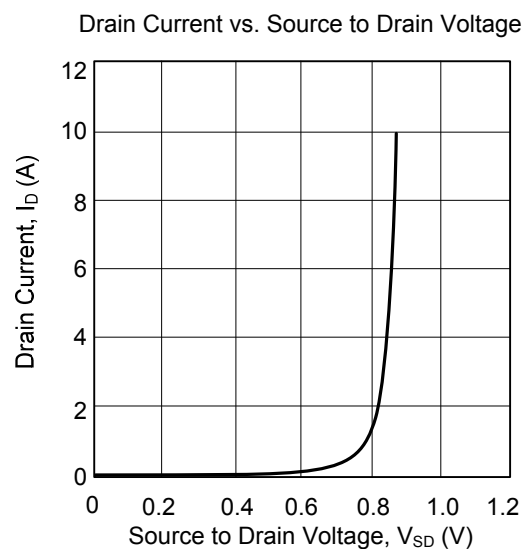
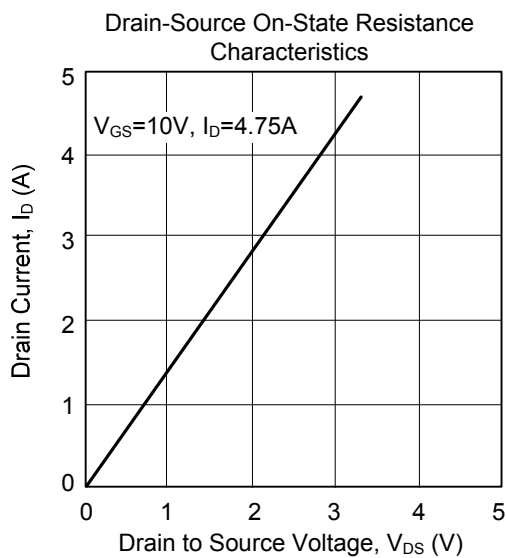
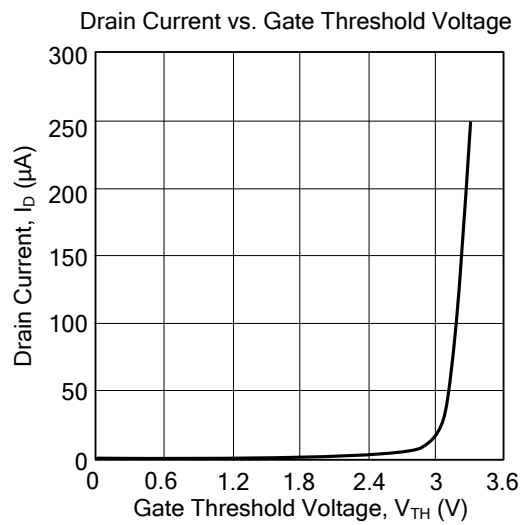
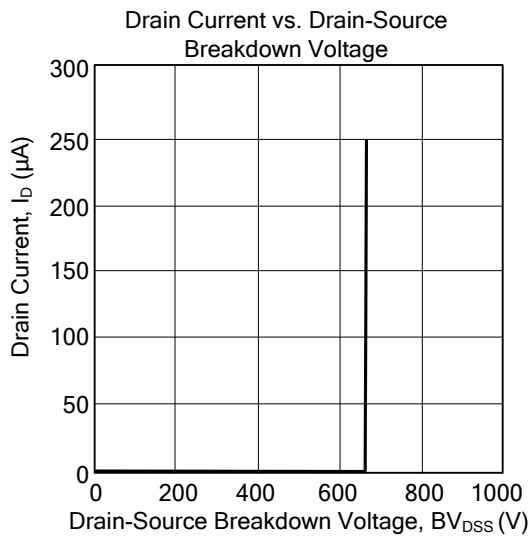


**Unclamped Inductive Switching Test Circuit**



**Unclamped Inductive Switching Waveforms**

### TYPICAL CHARACTERISTICS



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